#### SN54LS112A, SN54S112, SN74LS112A, SN74S112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR D2661, APRIL 1982-REVISED MARCH 1988

#### SDLS011

- Fully Buffered to Offer Maximum Isolation from External Disturbance
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

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These devices contain two independent J-K negative-edge-triggered flip-flops. A low level at the preset and clear inputs sets or resets the outputs regardless of the levels of the other inputs. When preset and clear are inactive (high), data at the J and K inputs meeting the setup time requirements are transferred to the outputs on the negative-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold time interval, data at the J and K inputs may be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by tying J and K high.

The SN54LS112A and SN54S112 are characterized for operation over the full military temperature range of ~55°C to 125°C. The SN74LS112A and SN74S112A are characterized for operation from 0°C to 70°C.

#### FUNCTION TABLE (each flip-flop)

	IN	PUTS			ουπ	PUTS
PRE	<u>CLR</u>	CLK	J	К	a	ā
L	н	х	х	х	н	L
н	L	x	х	х	L	н
L	L	x	х	х	н†	H <sup>†</sup>
н	н	Ţ	L	L	a0	āο
н	н	Ŧ	н	L	н	L
н	н	Ļ	L	н	L	н
н	н	Ļ	н	н	TOG	GLE
н	н	н	x	x	ūο	āo

<sup>†</sup> The output levels in this configuration are not guaranteed to meet the minimum levels for  $V_{OH}$  if the lows at preset and clear are near  $V_{IL}$  minimum. Furthermore, this configuration is nonstable; that is, it will not persist when either preset or clear returns to its inactive (high) level.

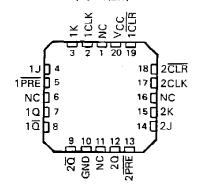
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Taxas instruments standard warranty. Production processing does not necessarily include testing of all parameters.



SN54LS112A, SN54S112...J OR W PACKAGE SN74LS112A, SN74S112A...D OR N PACKAGE (TOP VIEW)

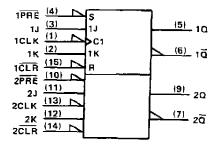
1CLK	1	U16	
1J	3	14	2CLR
1PRE	4	13	2CLK
10	5	12	2K
10	6	11	2J
20	7	10	2PRE
GND	8	9	20

SN54LS112A, SN54S112... FK PACKAGE (TOP VIEW)



NC-No internal connection

#### logic symbol<sup>‡</sup>



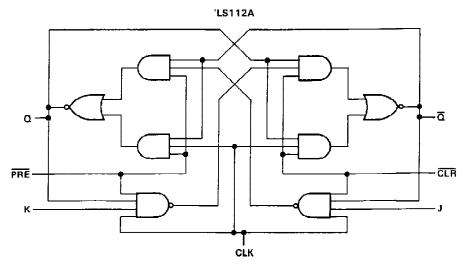
<sup>±</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

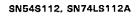
Pin numbers shown are for D, J, N, and W packages.

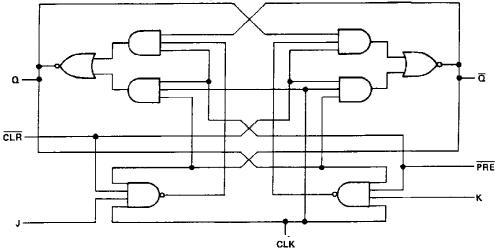
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# SN54LS112A, SN54S112, SN74LS112A, SN74S112A DUAL J-K NEGATIVE EDGE TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

logic diagrams (positive logic)

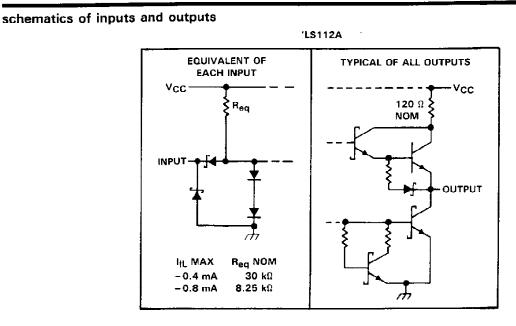




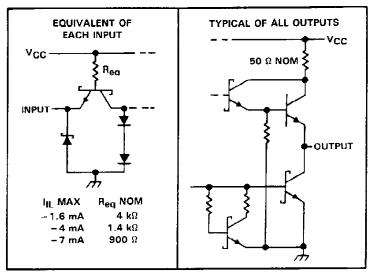




## SN54LS112A, SN54S112, SN74LS112A, SN74S112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR



SN54S112, SN74S112A



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)
Input voltage: 'LS112A
SN54LS112, SN74LS112A 5.5 V
Operating free-air temperature range: SN54'
SN74'
Storage temperature range

NOTE 1: Voltage values are with respect to network ground terminal.

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## SN54LS112A, SN74LS112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

#### recommended operating conditions

			SN	154LS11	2A	SN	74LS11	2A	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	v
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			0.8	V
юн	High-level output current				-0.4			-0.4	mΑ
<sup>I</sup> OL	Low-level output current				4			8	mΑ
fclock	Clock frequency		0		30	0		30	MHz
•	Pulse duration	CLK high	20		-	20			
t <sub>w</sub>	Foise duration	PRE or CLR low	25			25			ns
		Data high or low	20			20			
t <sub>su</sub>	Set up time-before CLK1	<b>CLR</b> inactive	25			25			ns
		PRE inactive	20			20			
th	Hold time-data after CLK1		0			0			Π\$
TA	Operating free-air temperature		- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	ARAMETER	TEST	CONDITIONS		SM	154LS11	2A	SN	UNIT		
P/	ANAIVIETER	TEST	CONDITIONS.		MIN	TYPI	MAX	MIN	TYPI	MAX	UNIT
VIK		$V_{CC} = MIN,$	$I_{1} = -18 \text{ mA}$		[		-1.5			- 1.5	V
∨он		$V_{CC} = MIN,$ $I_{OH} = -0.4 \text{ mA}$	V <sub>IH</sub> = 2 ∨,	V <sub>IL</sub> ≠ MAX,	2.5	3.4		2.7	3.4		v
		$V_{CC} = MIN,$ IOL = 4 mA	$V_{1L} = MAX,$	V <sub>IH</sub>		0.25	0.4		0.25	0.4	.,,
VOL		V <sub>CC</sub> = MIN, I <sub>OL</sub> = 8 mA	$V_{IL} = MAX,$	V <sub>IH</sub> = 2 V,					0.35	0.5	V
	J or K				[		0.1			0.1	
4	CLR or PRE	$V_{CC} = MAX,$	VI = 7 V				0.3			0.3	mA
•	CLK	1				_	0.4			0.4	
	JorK						20			20	
нн	CLR or PRE	$V_{CC} = MAX,$	VI = 2.7 V		-		60			60	μA
	CLK	1	·				80			80	
,	J or K	NA MAN					-0.4			-0.4	
ιL	All other	V <sub>CC</sub> = MAX,	vi = 0.4 v				-0.8			-0.8	mA
los <sup>§</sup>	<u> </u>	VCC = MAX,	see Note 2		- 20		- 100	- 20		- 100	mA
	otal)	$V_{CC} = MAX,$			<u> </u>	4	6		4	6	mА

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25 \,^{\circ}$ C.

<sup>§</sup>Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

NOTES: 2. For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V<sub>O</sub> = 2.25 V and 2.125 V for the '54 family and the '74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

3. With all outputs open, ICC is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded.



# SN54LS112A, SN74LS112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST COND	· • ···· · · · · · · · · · · · · · · ·	MIN	түр	мах	UNIT
fmax				<u> </u>	30	45		MHz
<sup>t</sup> PLH	CLR, PRE or CLK	<u>.</u> 	$R_{L} = 2 k\Omega$ ,	C <sub>L</sub> ⇒ 15 pF		15	20	<b></b>
<sup>t</sup> PHL	CLA, FRE OF CLK	2010				15	20	П\$

# switching characteristics, $V_{CC} = 5 V$ , $T_A = 25 °C$ (see Note 4)

NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

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## SN54S112, SN74S112A DUAL J.K NEGATIVE EDGE TRIGGERED FLIP FLOPS WITH PRESET AND CLEAR

### recommended operating conditions

			s	N54S11	2	SI	174511	2 <b>A</b>	-
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
ViH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	V
юн	High-level output current				- 1			- 1	mA
IOL .	Low-level output current				20			20	mΑ
		CLK high	6			6			
tw	Pulse duration	CLK low	6.5			6.5			пѕ
		PRE or CLR low	8			8			
t <sub>su</sub>	Set up time-before CLK4	Data high or low	7			7			ាទ
th	Hold time-data after CLK↓		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			CONDITIONS		5	SN54S1	12	SI	N74S11	2A	
PA	RAMETER	IESI	CONDITIONS		MIN	TYP <sup>‡</sup>	MAX	MIN	TYP‡	MAX	UNIT
VIK		$V_{CC} = MIN,$	lj = −18 mA				-1.2			-1.2	V
Voн		V <sub>CC</sub> ≠ MIN, I <sub>OH</sub> = −1 mA	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = MAX,	2.5	3.4		2.7	3.4		v
VOL		V <sub>CC</sub> = MIN, IOL = 20 mA	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> → 0.8 V,			0.5			0.5	۷
4		$V_{CC} = MAX.$	$V_1 = 5.5 V$				1			1	mA
	JorK	VCC = MAX	$y_{1} = 2.7 y_{1}$				50			50	μA
ήΗ	All other		vi = 2.7 v				100			100	μπ
	JorK						-1.6			- 1.6	
	CLR <sup>§</sup>						- 7			-7	mΑ
μL	PRE	$V_{CC} = MAX,$	$v_{\rm f} = 0.5 v$				- 7			- 7	mA
	CLK	1					-4			-4	
los¶		V <sub>CC</sub> = MAX			-40		- 100	- 40		~ 100	mA
ICC #		V <sub>CC</sub> = MAX.	see Note 3			15	25		15	25	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.

Sclear is tested with preset high and preset is tested with clear high.

Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

#Values are average per flip-flop.

NOTE 3: With all outputs open,  $I_{CC}$  is measured with the Q and  $\overline{Q}$  outputs high in turn. At the time of measurement, the clock input is grounded.



## SN54S112, SN74S112A DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	МАХ	UNIT	
f <sub>max</sub>					80	125		MHz
t <b>P</b> LH	PRE or CLR	Q or Q				4	7	ns
touu	PRE or CLR (CLK high)	Q or Q	R <sub>1</sub> = 280 Ω,	CL = 15 pF		5	7	
<sup>t</sup> PHL	PRE or CLR (CLK low)		n_ = 200 1/,		<u> </u>	5	7	ns
<sup>t</sup> PLH	СЦК	Q or Q	7			4	7	nŝ
<sup>t</sup> PHL		abia				5	7	ns

switching characteristics,  $V_{CC} = 5 V$ ,  $T_A = 25 °C$  (see Note 4)

NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

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10-Dec-2020

# **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07102BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07102B EA	Samples
JM38510/07102BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07102BFA	Samples
JM38510/30103B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Non-Green	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30103B2A	Samples
JM38510/30103BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30103BEA	Samples
JM38510/30103BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30103BFA	Samples
M38510/07102BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/07102B EA	Samples
M38510/07102BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07102BFA	Samples
M38510/30103B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Non-Green	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30103B2A	Samples
M38510/30103BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30103BEA	Samples
M38510/30103BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30103BFA	Samples
SN54LS112AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS112AJ	Samples
SN54S112J	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S112J	Samples
SN74LS112AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS112A	Samples
SN74LS112ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS112A	Samples
SN74LS112ADRE4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS112A	Samples
SN74LS112AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS112AN	Samples
SN74LS112ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS112A	Samples



Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74S112AN	ACTIVE	PDIP	N	16	25	RoHS & Green	(6) NIPDAU	N / A for Pkg Type	0 to 70	SN74S112AN	Samples
SNJ54LS112AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Non-Green	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 112AFK	Samples
SNJ54LS112AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS112AJ	Samples
SNJ54LS112AW	ACTIVE	CFP	W	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS112AW	Samples
SNJ54S112FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Non-Green	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 112FK	Samples
SNJ54S112J	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S112J	Samples
SNJ54S112W	ACTIVE	CFP	W	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S112W	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



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# PACKAGE OPTION ADDENDUM

10-Dec-2020

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS112A, SN74LS112A :

Catalog: SN74LS112A

• Military: SN54LS112A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

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## TAPE AND REEL INFORMATION

### REEL DIMENSIONS

Texas Instruments





TAPE AND REEL INFORMATION

#### TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS112ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS112ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

14-Jul-2012



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS112ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS112ANSR	SO	NS	16	2000	367.0	367.0	38.0

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP2-F16



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



4211283-4/E 08/12

# D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## MECHANICAL DATA

## PLASTIC SMALL-OUTLINE PACKAGE

### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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